





20V N-CHANNEL ENHANCEMENT MODE MOSFET

Product Summary

V _{(BR)DSS}	R _{DS(on)} Max	I _D max T _A = 25°C (Notes 4)
20V	200mΩ @ V _{GS} = 4.5V	1.73A
	260mΩ @ V _{GS} = 2.5 V	1.50A
	400mΩ @ V _{GS} = 1.8V	1.27A
	500mΩ @ V _{GS} = 1.5V	1.15A

Description and Applications

This MOSFET has been designed to minimize the on-state resistance $(R_{DS(on)})$ and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

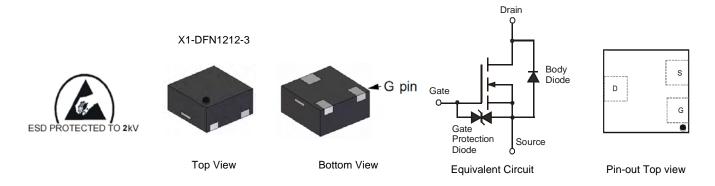
Load switch

Features and Benefits

- Low Gate Threshold Voltage
- · Fast Switching Speed
- "Lead Free", RoHS Compliant (Note 1)
- Halogen and Antimony Free. "Green" Device (Note 2)
- ESD Protected Gate 2KV
- Qualified to AEC-Q101 Standards for High Reliability

Mechanical Data

- Case: X1-DFN1212-3
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish NiPdAu over Copper leadframe. Solderable per MIL-STD-202, Method 208
- Weight: 0.005 grams (approximate)



Ordering Information (Note 3)

Part Number	Marking	Reel size (inches)	Tape width (mm)	Quantity per reel
DMN2300UFD-7	KS2	7	8	3000

Notes:

- 1. No purposefully added lead
- 2. Diodes Inc's "Green" policy can be found on our website at http://www.diodes.com.
- 3. For packaging details, go to our website at http://www.diodes.com.

Marking Information



KS2 = Product Type Marking Code YM = Date Code Marking Y = Year (ex: Y = 2011) M = Month (ex: 9 = September)

Date Code Key

Year	201	1	2012		2013	20	14	2015		2016		2017
Code	Υ		Z		Α	[3	С		D		E
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	N	D





Maximum Ratings @TA = 25°C unless otherwise specified

Characteristic			Symbol	Value	Unit
Drain-Source Voltage			V_{DSS}	20	V
Gate-Source Voltage			V _{GSS}	±8	V
III Ontiniiolie Drain Clirrent	01	T _A = 25°C (Note 4)	I _D	1.73	
	Steady State	T _A = 85°C (Note 4)		1.34	Α
	State	T _A = 25°C (Note 5)		1.21	
Pulsed Drain Current (Note 6)			I _{DM}	6.0	А

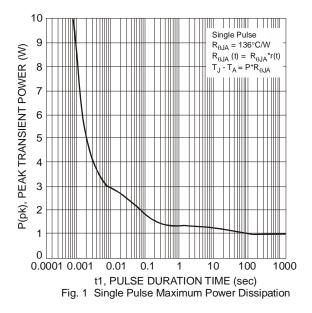
Thermal Characteristics @TA = 25°C unless otherwise specified

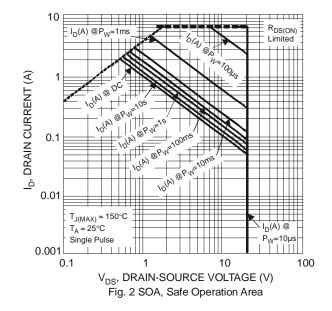
Characteristic	Symbol	Value	Unit	
Power Discipation	(Note 4)	D	0.96	W
Power Dissipation	(Note 5)	P_{D}	0.47	W
Thermal Resistance, Junction to Ambient	(Note 4)	В	130	°C/W
Thermal Resistance, Junction to Ambient	(Note 5)	$R_{\theta JA}$	265	°C/W
Operating and Storage Temperature Range		T _J , T _{STG}	-55 to +150	°C

Notes:

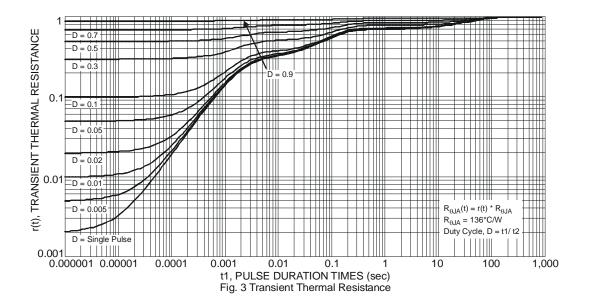
- 4. For a device surface mounted on 15mm x 15mm x 1.6mm FR4 PCB with high coverage of 2oz copper, in still air conditions; the device is measured when operating in a steady-state condition.
- 5. Same as note 4, except the device is mounted on minimum recommended pad layout.
- 6. Device mounted on minimum recommended pad layout test board, 10µs pulse duty cycle = 1%.

Thermal Characteristics









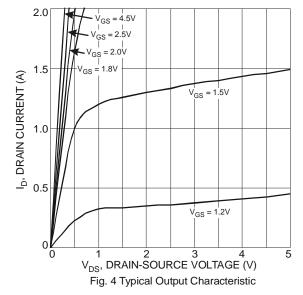
Electrical Characteristics @TA = 25°C unless otherwise specified

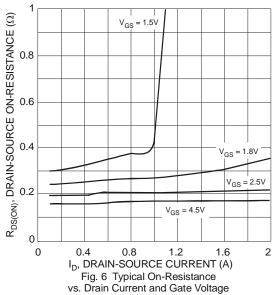
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 7)						
Drain-Source Breakdown Voltage	BV _{DSS}	20	-	-	V	$V_{GS} = 0V, I_D = 250\mu A$
Zero Gate Voltage Drain Current T _J = 25°C	I _{DSS}	-	-	1	μΑ	$V_{DS} = 20V, V_{GS} = 0V$
Gate-Source Leakage	I _{GSS}	-	-	±10	μΑ	$V_{GS} = \pm 8V$, $V_{DS} = 0V$
ON CHARACTERISTICS (Note 7)		-		-		
Gate Threshold Voltage	V _{GS(th)}	0.45	-	0.95	V	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$
				200		$V_{GS} = 4.5V, I_D = 900mA$
Static Dunin Course On Besistance	5			260		$V_{GS} = 2.5V, I_D = 800mA$
Static Drain-Source On-Resistance	R _{DS (ON)}	-	-	400	mΩ	$V_{GS} = 1.8V, I_D = 700mA$
				500		$V_{GS} = 1.5V, I_D = 200mA$
Forward Transfer Admittance	Y _{fs}	40	-	-	mS	$V_{DS} = 3V, I_{D} = 300 \text{mA}$
Diode Forward Voltage	V _{SD}	-	0.7	1.2	V	V _{GS} = 0V, I _S = 300mA
DYNAMIC CHARACTERISTICS	•	•		•	•	•
Input Capacitance	C _{iss}	-	67.62	-	pF	N 051/ N 01/
Output Capacitance	Coss	-	9.74	-	pF	$V_{DS} = 25V, V_{GS} = 0V,$ - f = 1.0MHz
Reverse Transfer Capacitance	C _{rss}	-	7.58	-	pF	71 = 1.0IVIH2
Gate Resistance	Rg	-	68.51	-	Ω	$V_{DS} = 0V$, $V_{GS} = 0V$, $f = 1MHz$
Total Gate Charge (Note 8)	Qq	-	0.89	2	nC	4.51/.1/451/
Gate-Source Charge	Q _{qs}	-	0.14	-	nC	$V_{GS} = 4.5V, V_{DS} = 15V,$
Gate-Drain Charge	Q _{gd}	-	0.16	-	nC	I _D = 1A
Turn-On Delay Time	t _{D(on)}	-	4.92	-	ns	
Turn-On Rise Time	tr	-	6.93	-	ns	$V_{DS} = 10V, I_{D} = 1A$
Turn-Off Delay Time	t _{D(off)}	-	21.71	-	ns	$V_{GS} = 10V, R_G = 6\Omega$
Turn-Off Fall Time	t _f	-	10.62	-	ns	7

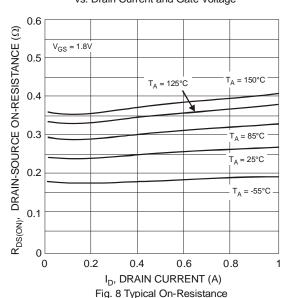
Notes: 7. Short duration pulse test used to minimize self-heating effect.

8. Guarantee by design.

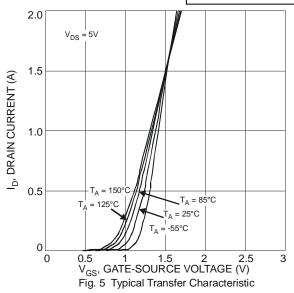


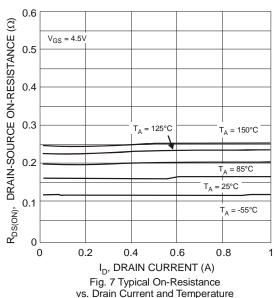






vs. Drain Current and Temperature





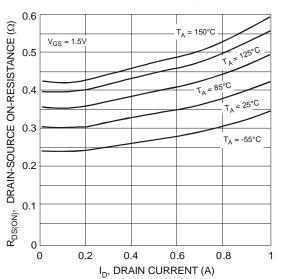
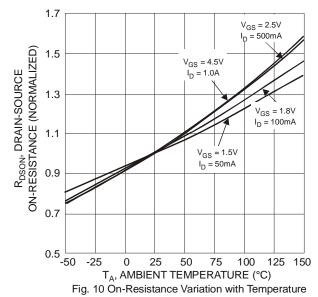
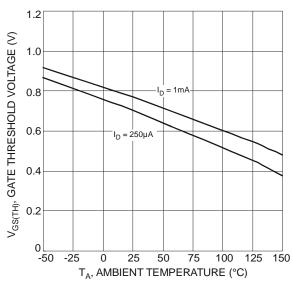
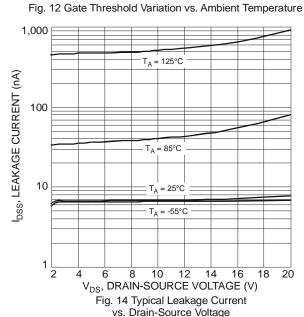


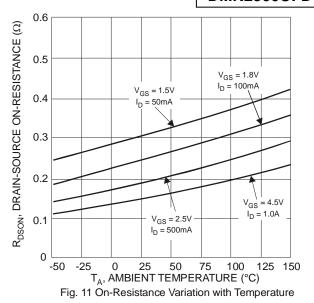
Fig. 9 Typical On-Resistance vs. Drain Current and Temperature

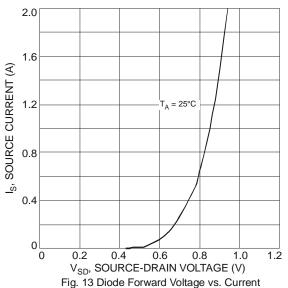


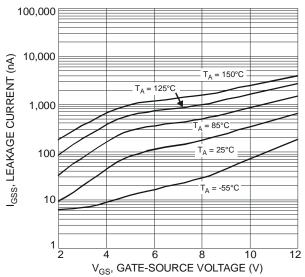




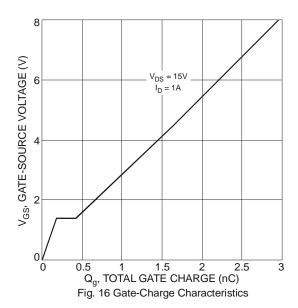




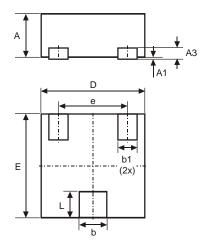






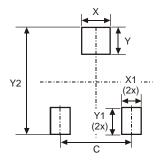


Package Outline Dimensions



X1-DFN1212-3						
Dim	Min	Max	Тур			
Α	0.47	0.53	0.50			
A1	0	0.05	0.02			
A3	-	-	0.13			
b	0.27	0.37	0.32			
b1	0.17	0.27	0.22			
ם	1.15	1.25	1.20			
Е	1.15	1.25	1.20			
е	•	•	0.80			
L	0.25	0.35	0.30			
All Dimensions in mm						

Suggested Pad Layout



Dimensions	Value (in mm)
C	0.80
Х	0.42
X1	0.32
Υ	0.50
Y1	0.50
Y2	1.50





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